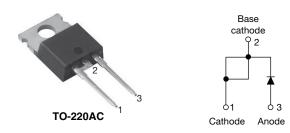


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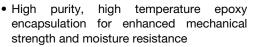
## **High Performance Schottky Rectifier, 10 A**



PRIMARY CHARACTERISTICS					
I <sub>F(AV)</sub>	10 A				
$V_{R}$	35 V, 40 V, 45 V				
V <sub>F</sub> at I <sub>F</sub>	0.49 V				
I <sub>RM</sub>	15 mA at 125 °C				
T <sub>J</sub> max.	175 °C				
E <sub>AS</sub>	13 mJ				
Package	TO-220AC				
Circuit configuration	Single				

#### **FEATURES**

- 175 °C T<sub>J</sub> operation
- Low forward voltage drop
- High frequency operation





- Guard ring for enhanced ruggedness and long term reliability
- Meet JESD 201 class 2 whisker test
- AEC-Q101 qualified
- Material categorization: for definitions of compliance please see <a href="https://www.vishay.com/doc?99912">www.vishay.com/doc?99912</a>

### **DESCRIPTION**

The VS-10TQ... Schottky rectifier series has been optimized for low reverse leakage at high temperature. The proprietary barrier technology allows for reliable operation up to 175 °C junction temperature. Typical applications are in switching power supplies, converters, freewheeling diodes, and reverse battery protection.

MAJOR RATINGS AND CHARACTERISTICS						
SYMBOL	CHARACTERISTICS	VALUES	UNITS			
I <sub>F(AV)</sub>	Rectangular waveform	10	Α			
$V_{RRM}$		35/45	V			
I <sub>FSM</sub>	t <sub>p</sub> = 5 μs sine	1050	Α			
$V_{F}$	10 A <sub>pk</sub> , T <sub>J</sub> = 125 °C	0.49	V			
T <sub>J</sub>	Range	-55 to +175	°C			

VOLTAGE RATINGS							
PARAMETER	VS-10TQ045HN3	UNITS					
Maximum DC reverse voltage	$V_{R}$	35	40	45	V		
Maximum working peak reverse voltage	$V_{RWM}$	33			V		

ABSOLUTE MAXIMUM RATINGS						
PARAMETER	SYMBOL	TEST COND	VALUES	UNITS		
Maximum average forward current See fig. 5	I <sub>F(AV)</sub>	50 % duty cycle at T <sub>C</sub> = 151 °C,	10			
Maximum peak one cycle non-repetitive surge current	l=	5 μs sine or 3 μs rect. pulse	μs sine or 3 μs rect. pulse Following any rated load condition and with rated		Α	
See fig. 7	I <sub>FSM</sub>	10 ms sine or 6 ms rect. pulse	V <sub>RRM</sub> applied	280		
Non-repetitive avalanche energy	E <sub>AS</sub>	T <sub>J</sub> = 25 °C, I <sub>AS</sub> = 2 A, L = 6.5 mH		13	mJ	
Repetitive avalanche current	I <sub>AR</sub>	Current decaying linearly to zero in 1 $\mu$ s Frequency limited by $T_J$ maximum $V_A = 1.5 \text{ x } V_R$ typical		2	Α	



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ELECTRICAL SPECIFICATIONS						
PARAMETER	SYMBOL	TEST CO	NDITIONS	VALUES	UNITS	
		10 A	T 05.00	0.57	V	
Maximum forward voltage drop	V (1)	20 A	T <sub>J</sub> = 25 °C	0.67		
See fig. 1	V <sub>FM</sub> <sup>(1)</sup>	10 A	T <sub>J</sub> = 125 °C	0.49		
		20 A		0.61		
Maximum reverse leakage current	I <sub>RM</sub> <sup>(1)</sup>	T <sub>J</sub> = 25 °C	$V_{R}$ = Rated $V_{R}$	2	mA	
See fig. 2	'RM \''	T <sub>J</sub> = 125 °C	VR = nateu VR	15		
Maximum junction capacitance	C <sub>T</sub>	$V_R = 5 V_{DC}$ (test signal ran	900	pF		
Typical series inductance	L <sub>S</sub>	Measured lead to lead 5 mm from package body		8.0	nH	
Maximum voltage rate of change	dV/dt	Rated V <sub>R</sub>	10 000	V/µs		

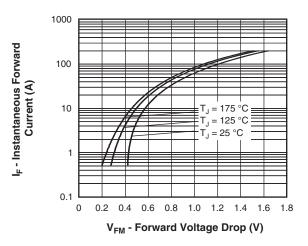
#### Note

 $<sup>^{(1)}\,</sup>$  Pulse width < 300  $\mu s,$  duty cycle < 2 %

THERMAL - MECHANICAL SPECIFICATIONS						
PARAMETER		SYMBOL	TEST CONDITIONS	VALUES	UNITS	
Maximum junction and storage temperature ra		T <sub>J</sub> , T <sub>Stg</sub>		-55 to +175	°C	
Maximum thermal resistance, junction to case  Typical thermal resistance, case to heatsink		R <sub>thJC</sub>	DC operation See fig. 4	2.0	°C/W	
		R <sub>thCS</sub>	Mounting surface, smooth and greased	0.50	C/VV	
Approximate weight	A construction of the			2	g	
Approximate weight				0.07	oz.	
Mounting torque	minimum			6 (5)	kgf. cm	
Mounting torque maximum				12 (10)	(lbf. in)	
Marking device				10TQ035H		
			Case style TO-220AC	10TQ040H		
				10TQ	045H	

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1000  $T_J = 175 \,^{\circ}\text{C}$ 100 I<sub>R</sub> - Reverse Current (mA) 10 T<sub>J</sub> = 150 °C T<sub>1</sub> = 125 °C T<sub>.1</sub> = 100 °C 0.1 <sub>1</sub>= 75 °C 0.01 50 °C 0.001 25 °C 0.0001 15 20 25 30 35 40 0 10 V<sub>R</sub> - Reverse Voltage (V)

Fig. 1 - Maximum Forward Voltage Drop Characteristics

Fig. 2 - Typical Values of Reverse Current vs. Reverse Voltage

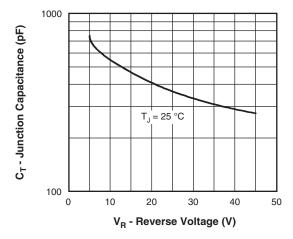


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage

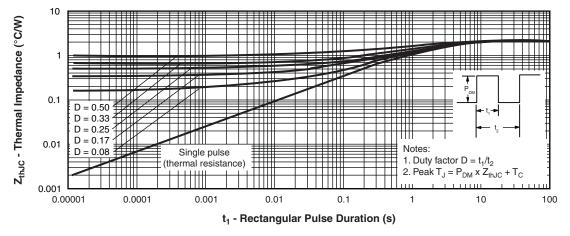


Fig. 4 - Maximum Thermal Impedance Z<sub>thJC</sub> Characteristics

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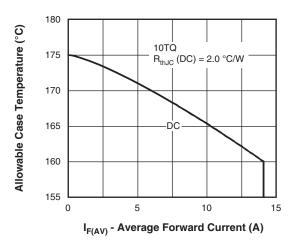


Fig. 5 - Maximum Allowable Case Temperature vs. Average Forward Current

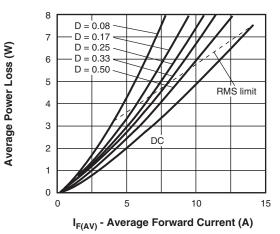


Fig. 6 - Forward Power Loss Characteristics

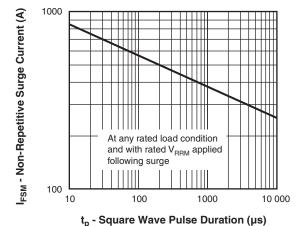


Fig. 7 - Maximum Non-Repetitive Surge Current

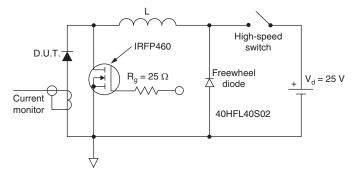


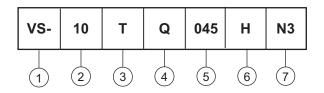
Fig. 8 - Unclamped Inductive Test Circuit

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### **ORDERING INFORMATION TABLE**

**Device code** 



1 - Vishay Semiconductors product

2 - Current rating (10 = 10 A)

3 - Package:

T = TO-220

4 - Schottky "Q" series

035 = 35 V

5 - Voltage ratings

040 = 40 V045 = 45 V

6 - H = AEC-Q101 qualified

7 - Environmental digit

• N3 = halogen-free, RoHS-compliant, and totally lead (Pb)-free

ORDERING INFORMATION (Example)						
PREFERRED P/N	QUANTITY PER T/R	MINIMUM ORDER QUANTITY	PACKAGING DESCRIPTION			
VS-10TQ035HN3	50	1000	Antistatic plastic tube			
VS-10TQ040HN3	50	1000	Antistatic plastic tube			
VS-10TQ045HN3	50	1000	Antistatic plastic tube			

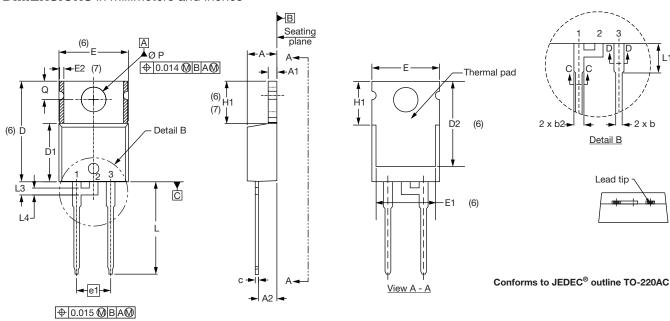
LINKS TO RELATED DOCUMENTS	
Dimensions	www.vishay.com/doc?95221
Part marking information	www.vishay.com/doc?95068



## Vishay Semiconductors

### **TO-220AC**

### **DIMENSIONS** in millimeters and inches



CVMDOL	YMBOL		INC	INCHES		
STIVIBUL	MIN.	MAX.	MIN.	MAX.	NOTES	
Α	4.25	4.65	0.167	0.183		
A1	1.14	1.40	0.045	0.055		
A2	2.56	2.92	0.101	0.115		
b	0.69	1.01	0.027	0.040		
b1	0.38	0.97	0.015	0.038	4	
b2	1.20	1.73	0.047	0.068		
b3	1.14	1.73	0.045	0.068	4	
С	0.36	0.61	0.014	0.024		
c1	0.36	0.56	0.014	0.022	4	
D	14.85	15.25	0.585	0.600	3	
D1	8.38	9.02	0.330	0.355		
D2	11.68	12.88	0.460	0.507	6	
E	10.11	10.51	0.398	0.414	3, 6	

MILLIMETERS		INCHES		NOTES
MIN.	MAX.	MIN.	MAX.	NOTES
6.86	8.89	0.270	0.350	6
-	0.76	-	0.030	7
4.88	5.28	0.192	0.208	
5.84	6.86	0.230	0.270	6, 7
13.52	14.02	0.532	0.552	
3.32	3.82	0.131	0.150	2
1.78	2.13	0.070	0.084	
0.76	1.27	0.030	0.050	2
3.54	3.73	0.139	0.147	
2.60	3.00	0.102	0.118	
	MIN. 6.86 - 4.88 5.84 13.52 3.32 1.78 0.76 3.54	MIN.         MAX.           6.86         8.89           -         0.76           4.88         5.28           5.84         6.86           13.52         14.02           3.32         3.82           1.78         2.13           0.76         1.27           3.54         3.73	MIN.         MAX.         MIN.           6.86         8.89         0.270           -         0.76         -           4.88         5.28         0.192           5.84         6.86         0.230           13.52         14.02         0.532           3.32         3.82         0.131           1.78         2.13         0.070           0.76         1.27         0.030           3.54         3.73         0.139	MIN.         MAX.         MIN.         MAX.           6.86         8.89         0.270         0.350           -         0.76         -         0.030           4.88         5.28         0.192         0.208           5.84         6.86         0.230         0.270           13.52         14.02         0.532         0.552           3.32         3.82         0.131         0.150           1.78         2.13         0.070         0.084           0.76         1.27         0.030         0.050           3.54         3.73         0.139         0.147

### Notes

- (1) Dimensioning and tolerancing as per ASME Y14.5M-1994
- (2) Lead dimension and finish uncontrolled in L1
- (3) Dimension D, D1 and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body
- (4) Dimension b1, b3 and c1 apply to base metal only
- (5) Controlling dimension: inches
- (6) Thermal pad contour optional within dimensions E, H1, D2 and E1
- (7) Dimension E2 x H1 define a zone where stamping and singulation irregularities are allowed
- (8) Outline conforms to JEDEC TO-220, D2 (minimum) where dimensions are derived from the actual package outline



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